

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Dongming Zhu et al.

Title:

PECEIVED TO 1700 LOW CONDUCTIVITY AND SINTERING-RESISTANT THERMAL

**BARRIER COATINGS** 

Serial No.:

09/904,084

Art Unit: 1755

Filed:

July 12, 2001

Examiner:

Paul Marcantoni

Docket:

33253US1

## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. § 1.98, applicant is submitting herewith Form PTO-1449 listing references for consideration by the Examiner. Also submitted herewith is a legible copy of each reference listed.

If any further fees are required by this communication, please charge such fees to our Deposit Account No. 16-0820, Order No. 33253US1.

Respectfully submitted,

PEARNE & GORDON LLP

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## NFORMATION DISCLOSURE CITATION

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

BY APPLICANT

(USE SEVERAL SHEETS IF NECESSARY)

ATTY. DOCKET NO. 33253US1

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FILING DATE:

**GROUP ART** UNIT:

July 12, 2003

1755

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			U.S. P	ATENT DOCUME	NTS			
Examiner Initial		Document No.	Date	Name		Class	Subclass	Filing Date If. Appropriate
	A	4,055,705	10/1977	Stecura et al.				
	В	5,652,044	7/1997	Rickerby				
	С	6,025,078	2/2000	Rickerby et al	•			
	D	6,440,575	8/2002	Heimberg et a	d.			
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		OTHER REFE	RENCES (In	cluding Author, Title. D	ate, Perti	nent Pag	es, Etc.)	Maria Maria
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*Examiner: Initial if reference considered, regardless of whether citation is in conformance with MPEP 609; Draw line through citif not in conformance and not considered. Include copy of this form with next communication to applicant.								through citation